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Page(s): 144 -150

[Abstract] [PDF Full-Text] CNF

2 New developments in excimer laser micromachining by image projection

Microengineering Applications in Optoelectronics, IEE Colloquium on , 1996 Page(s): 1/1 -1/2

[Abstract] [PDF Full-Text] CNF

3 Compatibility of common MCM-D dielectrics with scanning laser ablation-vi generation processes

Tessier, T.G.; Chandler, G.

Électronic Components and Technology Conference, 1992. Proceedings., 42nd , 1992

Page(s): 763 -769

[Abstract] [PDF Full-Text] CNF

4 Via processing options for MCM-D fabrication: excimer laser ablation vs. reactive ion etching

Tessier, T.G.; Hoffman, W.F.; Stafford, J.W.

Electronic Components and Technology Conference, 1991. Proceedings., 41st, 1991

Page(s): 827 -834

[Abstract] [PDF Full-Text] CNF

5 Patterning of dispenser cathode surfaces to a controlled porosity

Garner, C.E.; Deininger, W.D.; Gibson, J.; Thomas, R.

Electron Devices, IEEE Transactions on , Volume: 36 Issue: 1 Part: 2 , Jan. 1989

Page(s): 158 -168

[Abstract] [PDF Full-Text] JNL